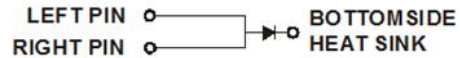
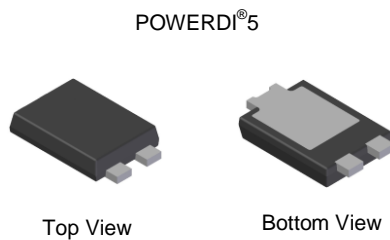


Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Reverse Leakage Current
- Low Forward Voltage Drop
- High Forward Surge Current Capability
- **Lead-Free Finish; RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: POWERDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208③
- Polarity: See Diagram
- Weight: 0.093 grams (Approximate)



Note: Pins Left & Right must be electrically connected at the printed circuit board.

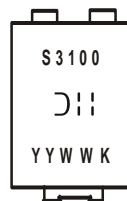
Ordering Information (Note 4)

Part Number	Case	Packaging
PDS3100-13	POWERDI [®] 5	5,000/Tape & Reel

- Notes:
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information

POWERDI[®]5



S3100 = Product Type Marking Code
 D11 = Manufacturers' Code Marking
 YYWW = Date Code Marking
 YY = Last Digit of Year (ex: 15 for 2015)
 WW = Week Code (01 - 53)
 K = Factory Designator

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	100	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	70	V
Average Rectified Output Current	I _O	3	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	90	A

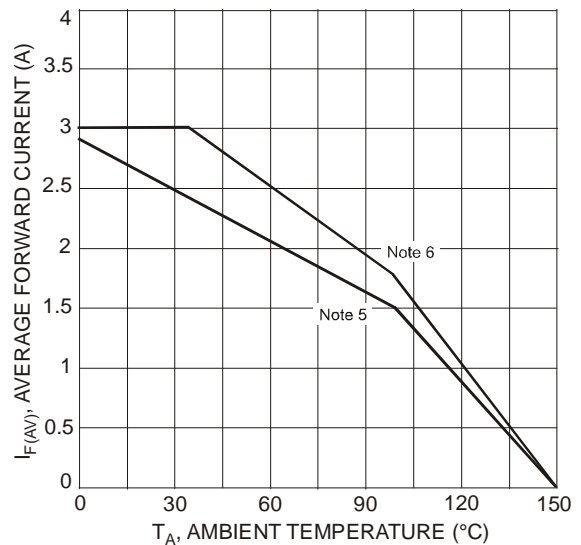
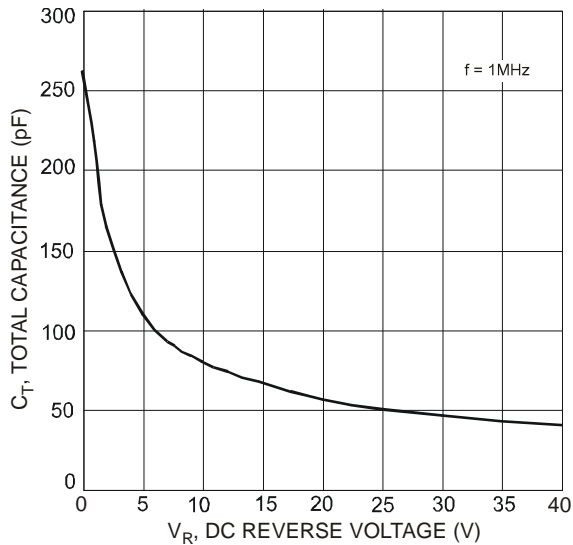
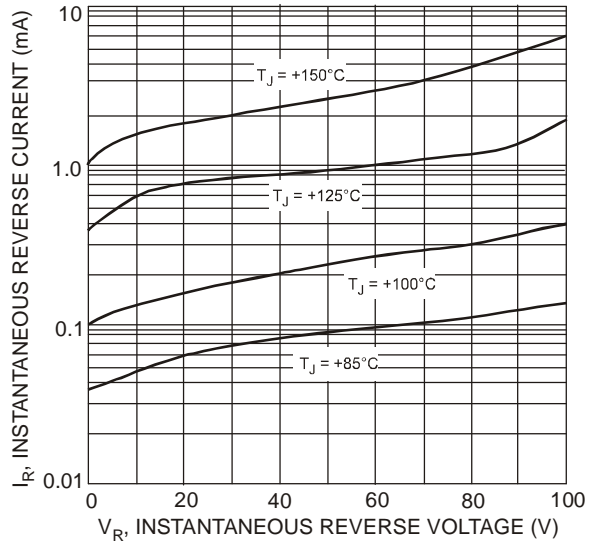
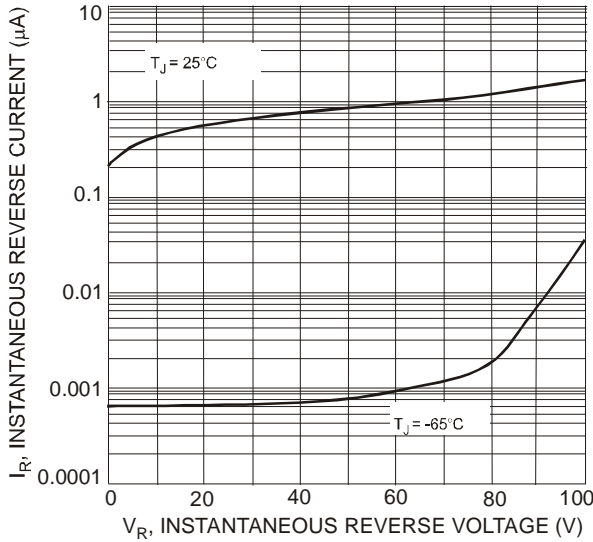
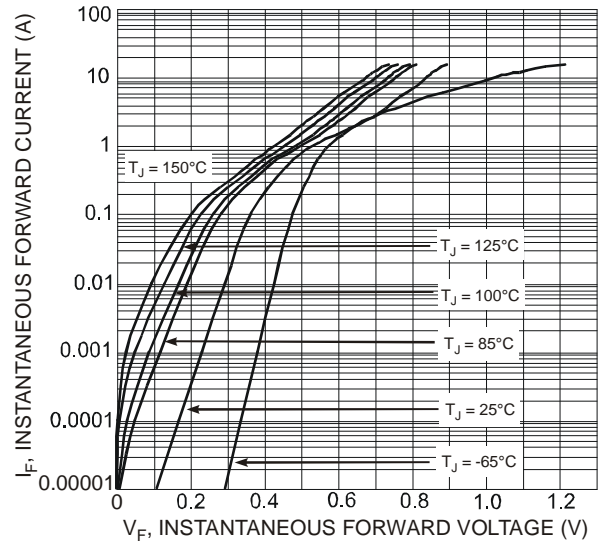
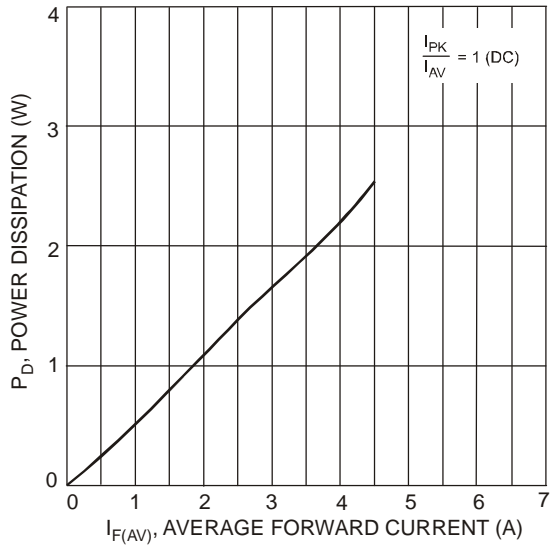
Thermal Characteristics

Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	R _{θJS}	—	6.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 5) T _A = +25°C	R _{θJA}	95	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 6) T _A = +25°C	R _{θJA}	70	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 7) T _A = +25°C	R _{θJA}	50	—	°C/W
Operating Temperature Range	T _J	-65 to +150		°C
Storage Temperature Range	T _{STG}	-65 to +175		°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 8)	V _{(BR)R}	100	—	—	V	I _R = 0.2mA
Forward Voltage	V _F	—	0.71	0.76	V	I _F = 3A, T _J = +25°C
		—	0.61	0.65		I _F = 3A, T _J = +100°C
		—	0.57	0.61		I _F = 3A, T _J = +125°C
		—	0.78	0.84		I _F = 6A, T _J = +25°C
		—	0.68	0.75		I _F = 6A, T _J = +100°C
		—	0.64	0.68		I _F = 6A, T _J = +125°C
Reverse Current (Note 8)	I _R	—	2	100	μA	T _J = +25°C, V _R = 100V
		—	0.4	5	mA	T _J = +100°C, V _R = 100V
		—	2	20	mA	T _J = +125°C, V _R = 100V

- Notes:
5. FR-4 PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
 6. Polyimide PCB, 2oz. Copper, minimum recommended pad layout per <http://www.diodes.com>.
 7. Polyimide PCB, 2oz. Copper. Cathode pad dimensions 9.4mm x 7.2mm. Anode pad dimensions 2.7mm x 1.6mm.
 8. Short duration pulse test used to minimize self-heating effect.



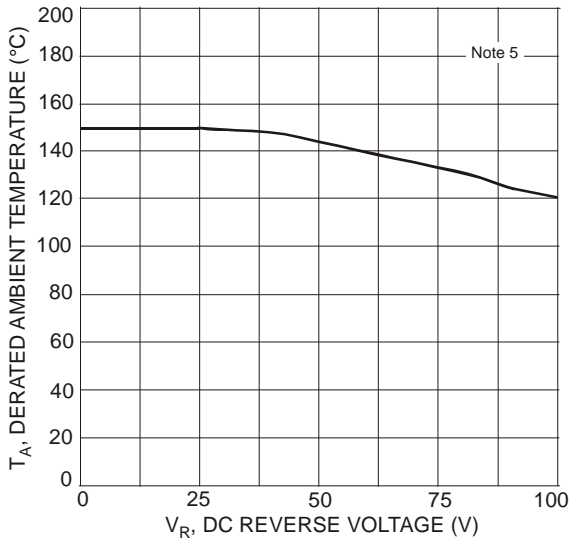
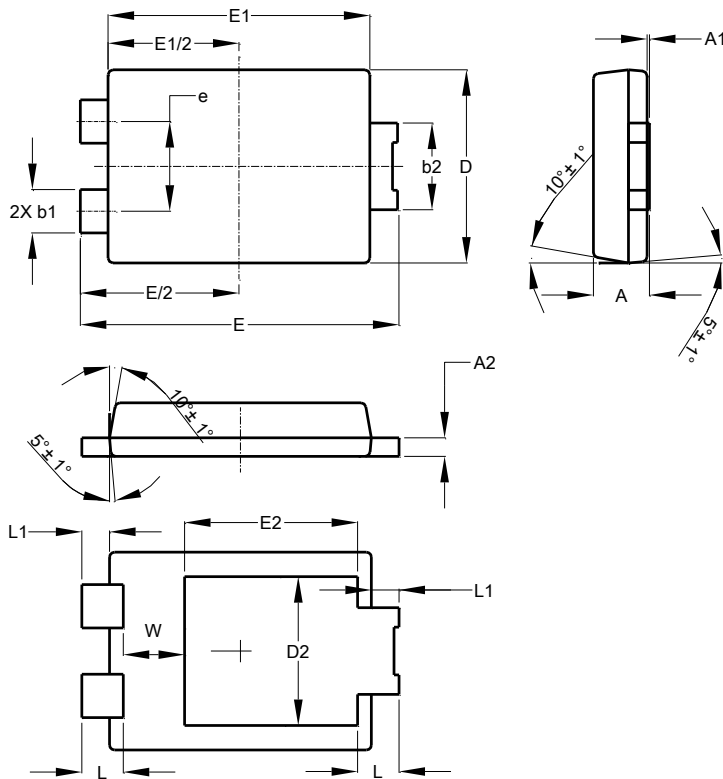


Fig. 7 Operating Temperature Derating

Package Outline Dimensions

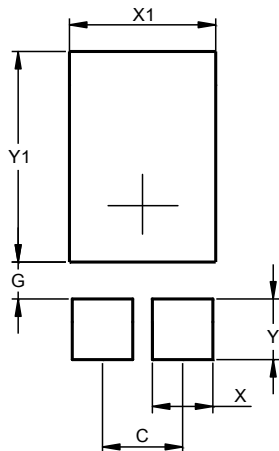
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



POWERDI [®] 5			
Dim	Min	Max	Typ
A	1.05	1.15	1.10
A1	0.00	0.05	--
A2	0.33	0.43	0.381
b1	0.80	0.99	0.89
b2	1.70	1.88	1.78
D	3.90	4.05	3.966
D2	--	--	3.054
E	6.40	6.60	6.504
e	--	--	1.84
E1	5.30	5.45	5.37
E2	--	--	3.549
L	0.75	0.95	0.85
L1	0.50	0.65	0.57
W	1.10	1.41	1.255
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
C	1.840
G	0.852
X	1.390
X1	3.360
Y	1.400
Y1	4.860

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